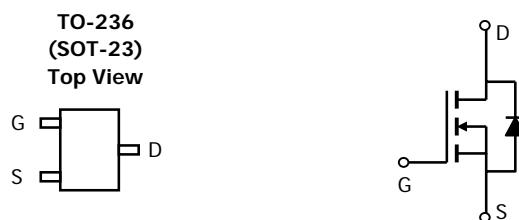


General Description	Features
<p>The AO3402/L uses advanced trench technology to provide excellent <math>R_{DS(ON)}</math>, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications. AO3402 and AO3402L are electrically identical.</p> <p>-RoHS Compliant -AO3402L is Halogen Free</p>	$V_{DS}$ (V) = 30V $I_D$ = 4 A ( $V_{GS}$ = 10V) $R_{DS(ON)} < 55m\Omega$ ( $V_{GS}$ = 10V) $R_{DS(ON)} < 70m\Omega$ ( $V_{GS}$ = 4.5V) $R_{DS(ON)} < 110m\Omega$ ( $V_{GS}$ = 2.5V)



<b>Absolute Maximum Ratings <math>T_A=25^\circ C</math> unless otherwise noted</b>				
Parameter	Symbol	Maximum	Units	
Drain-Source Voltage	$V_{DS}$	30	V	
Gate-Source Voltage	$V_{GS}$	$\pm 12$	V	
Continuous Drain Current <sup>A</sup>	$T_A=25^\circ C$	4	A	
$T_A=70^\circ C$		3.4		
Pulsed Drain Current <sup>B</sup>	$I_{DM}$	15		
Power Dissipation <sup>A</sup>	$T_A=25^\circ C$	1.4	W	
		1		
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	°C	

<b>Thermal Characteristics</b>				
Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient <sup>A</sup>	$t \leq 10s$	$R_{0JA}$	70	°C/W
Maximum Junction-to-Ambient <sup>A</sup>			100	°C/W
Maximum Junction-to-Lead <sup>C</sup>	Steady-State	$R_{0JL}$	63	°C/W
	Steady-State		80	

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$I_D=250\mu A, V_{GS}=0V$	30			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=24V, V_{GS}=0V$ $T_J=55^\circ C$		1		$\mu A$
				5		
$I_{GSS}$	Gate-Body leakage current	$V_{DS}=0V, V_{GS}=\pm 12V$			100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	0.6	1	1.4	V
$I_{D(ON)}$	On state drain current	$V_{GS}=4.5V, V_{DS}=5V$	10			A
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=4A$ $T_J=125^\circ C$		45	55	$m\Omega$
		$V_{GS}=4.5V, I_D=3A$		66	80	
		$V_{GS}=2.5V, I_D=2A$		55	70	
$g_{FS}$	Forward Transconductance	$V_{DS}=5V, I_D=4A$		8		S
$V_{SD}$	Diode Forward Voltage	$I_S=1A, V_{GS}=0V$		0.8	1	V
$I_S$	Maximum Body-Diode Continuous Current				2.5	A
<b>DYNAMIC PARAMETERS</b>						
$C_{iss}$	Input Capacitance	$V_{GS}=0V, V_{DS}=15V, f=1MHz$		390		pF
$C_{oss}$	Output Capacitance			54.5		pF
$C_{rss}$	Reverse Transfer Capacitance			41		pF
$R_g$	Gate resistance	$V_{GS}=0V, V_{DS}=0V, f=1MHz$		3		$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_g$	Total Gate Charge	$V_{GS}=4.5V, V_{DS}=15V, I_D=4A$		4.34		nC
$Q_{gs}$	Gate Source Charge			0.6		nC
$Q_{gd}$	Gate Drain Charge			1.38		nC
$t_{D(on)}$	Turn-On Delay Time	$V_{GS}=10V, V_{DS}=15V, R_L=3.75\Omega, R_{GEN}=6\Omega$		3.3		ns
$t_r$	Turn-On Rise Time			1		ns
$t_{D(off)}$	Turn-Off Delay Time			21.7		ns
$t_f$	Turn-Off Fall Time			2.1		ns
$t_{rr}$	Body Diode Reverse Recovery Time	$I_F=4A, dI/dt=100A/\mu s$		12		ns
$Q_{rr}$	Body Diode Reverse Recovery Charge	$I_F=4A, dI/dt=100A/\mu s$		6.3		nC

A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ C$ . The value in any given application depends on the user's specific board design. The current rating is based on the  $\leq 10s$  thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

D. The static characteristics in Figures 1 to 6, 12, 14 are obtained using <300μs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ C$ . The SOA curve provides a single pulse rating.

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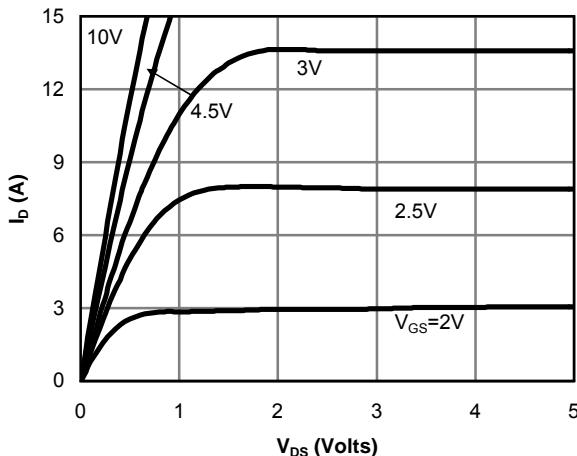


Fig 1: On-Region Characteristics

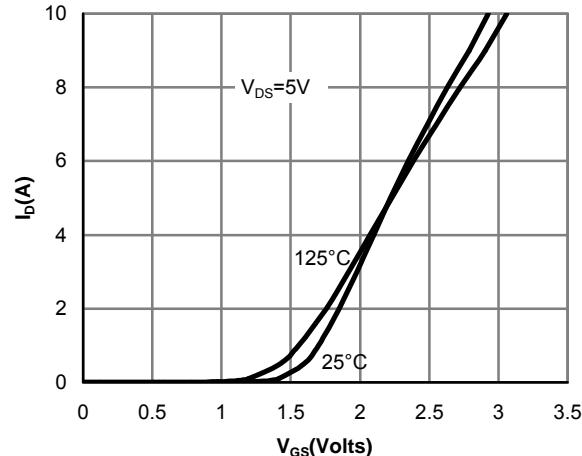


Figure 2: Transfer Characteristics

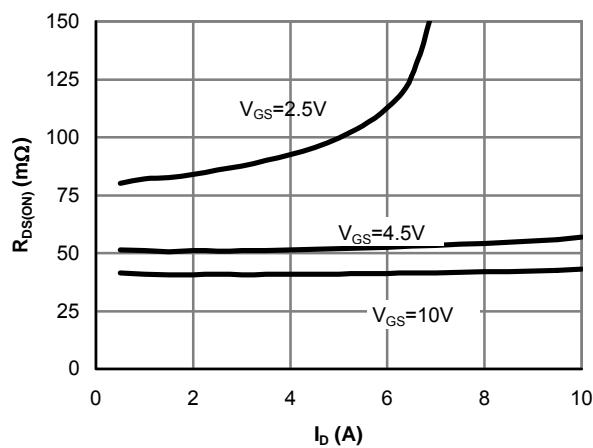


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

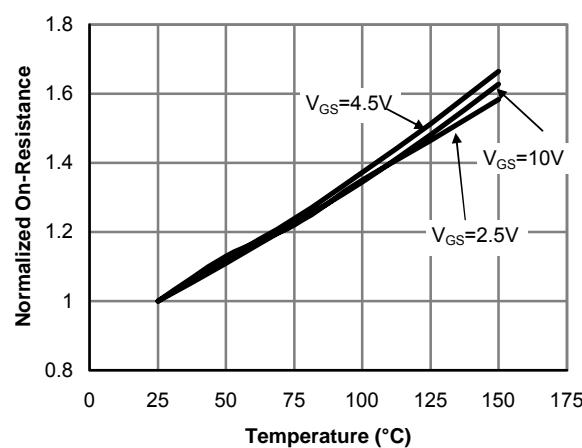


Figure 4: On-Resistance vs. Junction Temperature

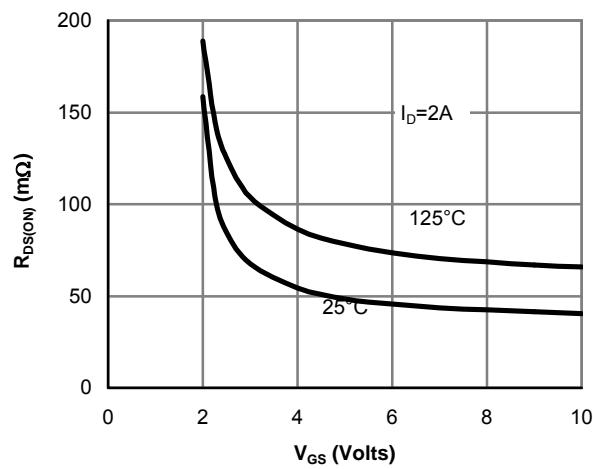


Figure 5: On-Resistance vs. Gate-Source Voltage

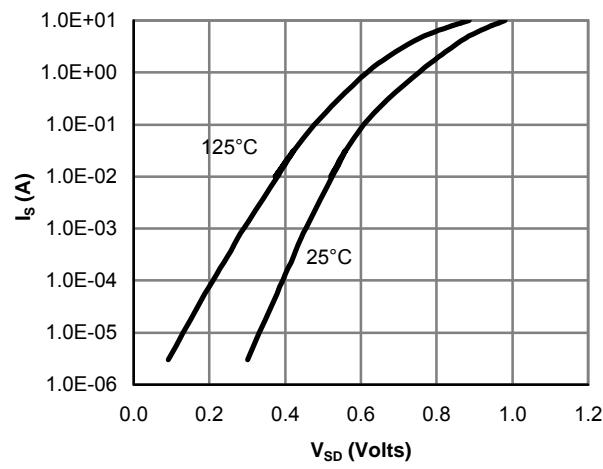


Figure 6: Body-Diode Characteristics

